

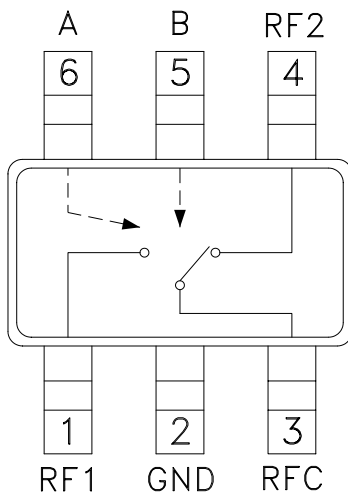
## GaAs MMIC SOT26 SPDT SWITCH, DC - 3 GHz

### Typical Applications

The HMC197 is ideal for:

- MMDS & WirelessLAN
- PCMCIA Wireless Cards
- Portable Wireless

### Functional Diagram



### Features

- Low Insertion Loss: 0.4 dB
- Ultra Small Package: SOT26
- Input IP3: +45 dBm
- Positive Control: 0/+3V @ 10 uA

### General Description

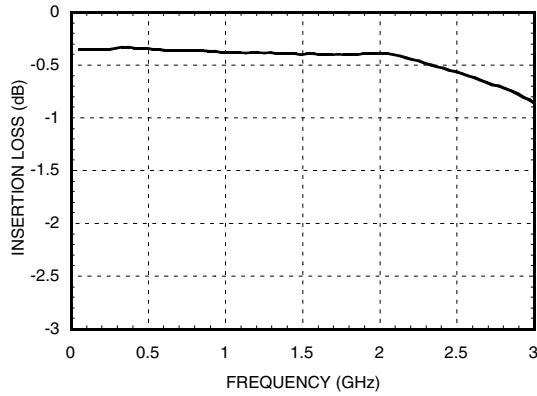
The HMC197 is a low-cost SPDT switch in a 6-lead SOT26 plastic package for use in general switching applications which require very low insertion loss and very small size. The device can control signals from DC to 3.0 GHz and is especially suited for 900 MHz, 1.8 - 2.2 GHz, and 2.4 GHz ISM applications with less than 1 dB loss. The design provides exceptional insertion loss performance, ideal for filter and receiver switching. RF1 and RF2 are reflective shorts when "Off". The two control voltages require a minimal amount of DC current and offer compatibility with most CMOS & TTL logic families. See HMC221 for same performance in an alternate SOT26 pin-out.

### Electrical Specifications, $T_A = +25^\circ C$ , $V_{ctl} = 0/+3$ to $+8$ Vdc, 50 Ohm System

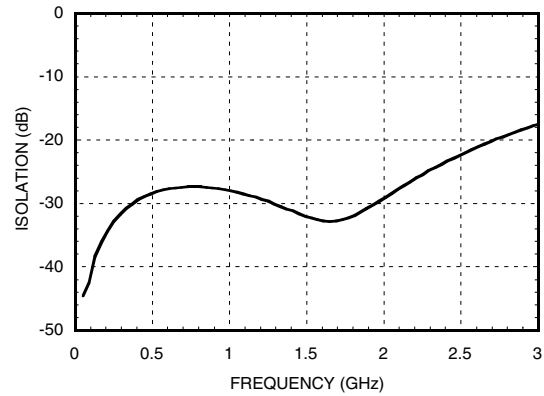
| Parameter  | Frequency     | Min.   | Typ. | Max.    | Units    |
|--|---------------|--|------|---------|----------|
| Insertion Loss   | DC - 1.0 GHz  |  | 0.4  | 0.7     | dB       |
|  | DC - 2.0 GHz  |  | 0.45 | 0.8     | dB       |
|  | DC - 2.5 GHz  |  | 0.7  | 0.9     | dB       |
|  | DC - 3.0 GHz  |  | 0.8  | 1.1     | dB       |
| Isolation  | DC - 1.0 GHz  | 24   | 28   |         | dB       |
|  | DC - 2.0 GHz  | 24   | 28   |         | dB       |
|  | DC - 2.5 GHz  | 18   | 22   |         | dB       |
|  | DC - 3.0 GHz  | 14   | 18   |         | dB       |
| Return Loss  | DC - 1.0 GHz  | 20   | 30   |         | dB       |
|  | DC - 2.0 GHz  | 16   | 22   |         | dB       |
|  | DC - 2.5 GHz  | 14   | 17   |         | dB       |
|  | DC - 3.0 GHz  | 10   | 13   |         | dB       |
| Input Power for 1dB Compression<br>( $V_{ctl} = 0/+5V$ )                                       | 0.5 - 1.0 GHz | 25   | 30   |         | dBm      |
|  | 0.5 - 3.0 GHz | 23   | 29   |         | dBm      |
| Input Third Order Intercept<br>( $V_{ctl} = 0/+5V$ ) (Two-tone Input Power = +7 dBm Each Tone) | 0.5 - 1.0 GHz | 40   | 45   |         | dBm      |
|  | 0.5 - 3.0 GHz | 38   | 43   |         | dBm      |
| Switching Characteristics  | DC - 3.0 GHz  |  |      |         |          |
|  |               | tRISE, tFALL (10/90% RF)<br>tON, tOFF (50% CTL to 10/90% RF) |      | 3<br>10 | ns<br>ns |

## GaAs MMIC SOT26 SPDT SWITCH, DC - 3 GHz

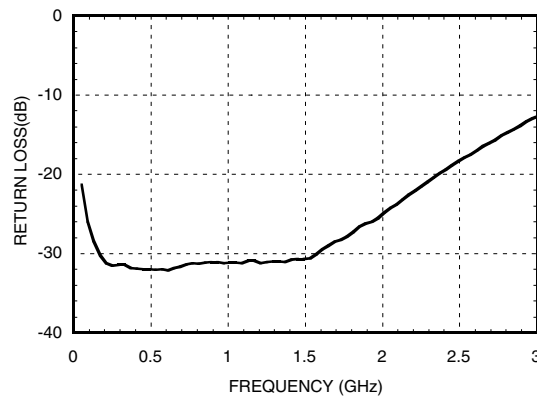
### Insertion Loss



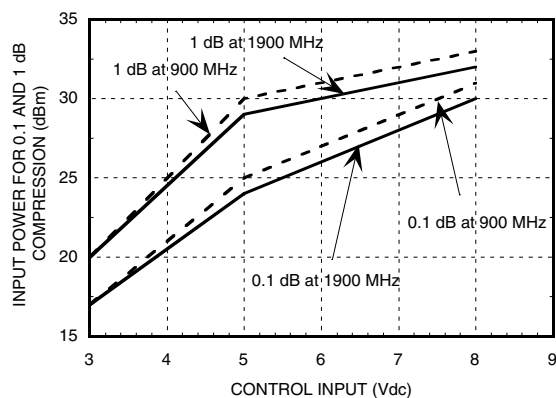
### Isolation



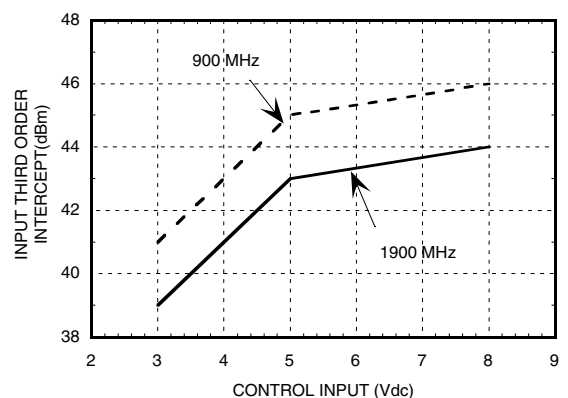
### Return Loss



### Input 0.1 and 1.0 dB Compression vs. Control Voltage



### Input Third Order Intercept Point vs. Control Voltage



## GaAs MMIC SOT26 SPDT SWITCH, DC - 3 GHz

### Compression vs. Control Voltage

| Control Input | Carrier at 900 MHz                       |  | Carrier at 1900 MHz                      |  |
|---------------|--|--|--|--|
|               | Input Power for 0.1 dB Compression (dBm) | Input Power for 1.0 dB Compression (dBm) | Input Power for 0.1 dB Compression (dBm) | Input Power for 1.0 dB Compression (dBm) |
| (Vdc)         | (dBm)                                    | (dBm)                                    | (dBm)                                    | (dBm)                                    |
| +3            | 17                                       | 20                                       | 17                                       | 20                                       |
| +5            | 25                                       | 30                                       | 24                                       | 29                                       |
| +8            | 31                                       | 33                                       | 30                                       | 32                                       |

Caution: Do not operate in 1dB compression at power levels above +31 dBm (Vctl = +5 Vdc) and do not "hot switch" power levels greater than +20 dBm (Vctl = +5Vdc).

DC blocks are required at ports RFC, RF1 and RF2.

### Distortion vs. Control Voltage

| Control Input | Third Order Intercept (dBm)<br>+7 dBm Each Tone |          |
|---------------|---|----------|
|               | 900 MHz   | 1900 MHz |
| (Vdc)         |   |          |
| +3            | 41  | 39       |
| +5            | 45  | 43       |
| +8            | 46  | 44       |

### Truth Table

\*Control Input Voltage Tolerances are  $\pm 0.2$  Vdc.

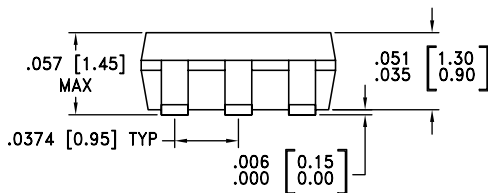
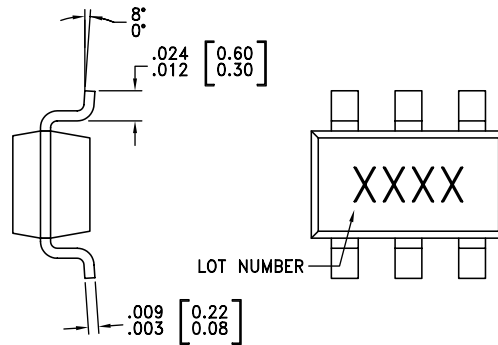
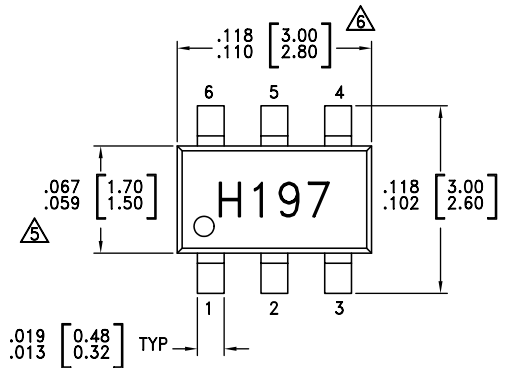
| Control Input* |         | Control Current |         | Signal Path |           |
|----------------|---------|-----------------|---------|-------------|-----------|
| A (Vdc)        | B (Vdc) | Ia (uA)         | Ib (uA) | RF to RF1   | RF to RF2 |
| 0              | +3      | -10             | 10      | ON          | OFF       |
| +3             | 0       | 10              | -10     | OFF         | ON        |
| 0              | +5      | -55             | 55      | ON          | OFF       |
| +5             | 0       | 55              | -55     | OFF         | ON        |
| 0              | +7      | -210            | 210     | ON          | OFF       |
| +7             | 0       | 210             | -210    | OFF         | ON        |
| 0              | +8      | -280            | 280     | ON          | OFF       |
| +8             | 0       | 280             | -280    | OFF         | ON        |

## GaAs MMIC SOT26 SPDT SWITCH, DC - 3 GHz

### Absolute Maximum Ratings

|                               |                 |
|-------------------------------|-----------------|
| Control Voltage Range (A & B) | -0.2 to +12 Vdc |
| Storage Temperature           | -65 to +150 °C  |
| Operating Temperature         | -40 to +85 °C   |

### Outline Drawing

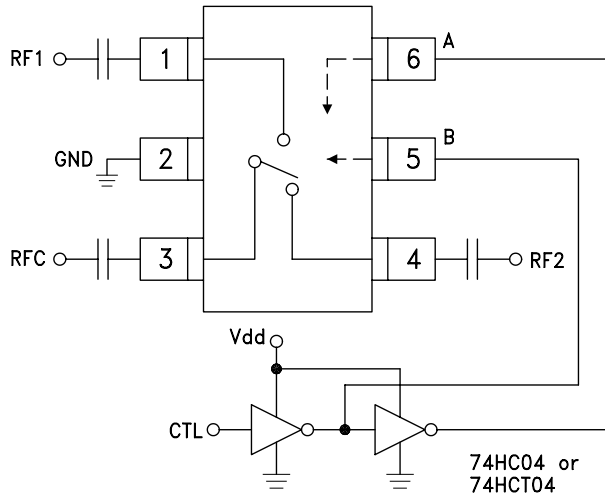


NOTES:

1. PACKAGE BODY MATERIAL: LOW STRESS INJECTION MOLDED PLASTIC SILICA AND SILICON IMPREGNATED.
2. LEADFRAME MATERIAL: COPPER ALLOY
3. LEADFRAME PLATING: Sn/Pb SOLDER
4. DIMENSIONS ARE IN INCHES [MILLIMETERS].
5. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
6. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
7. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

## GaAs MMIC SOT26 SPDT SWITCH, DC - 3 GHz

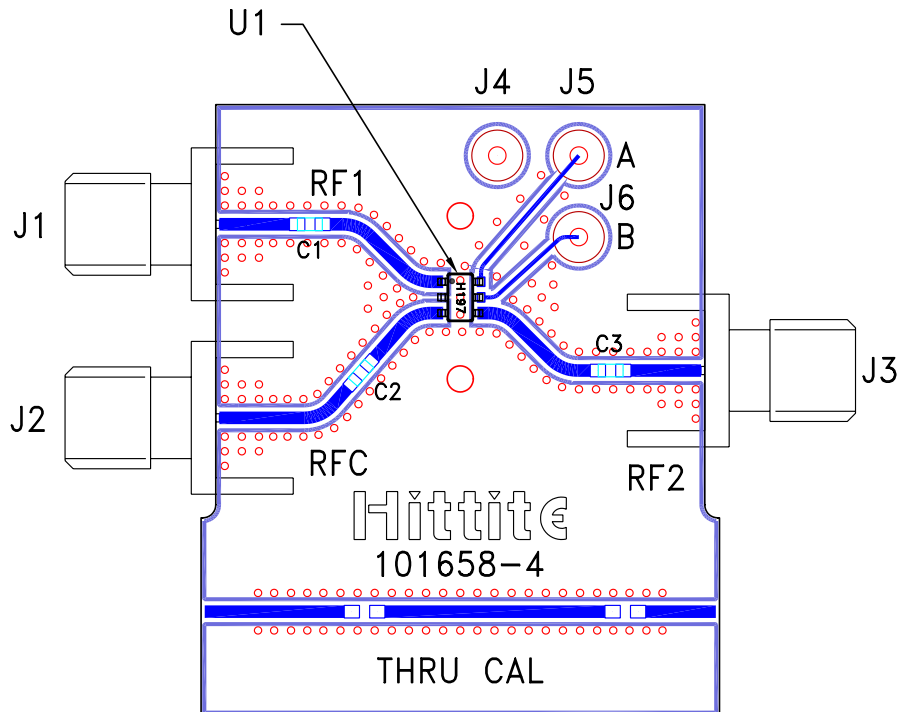
### Typical Application Circuit



**Notes:**

1. Set logic gate and switch Vdd = +3V to +5V and use HCT series logic to provide a TTL driver interface.
2. Control inputs A/B can be driven directly with CMOS logic (HC) with Vdd of 5 to 8 Volts applied to the CMOS logic gates.
3. DC Blocking capacitors are required for each RF port as shown. Capacitor value determines lowest frequency of operation.
4. Highest RF signal power capability is achieved with Vdd = +8V and A/B set to 0/+8V.

### Evaluation Circuit Board



### List of Material

| Item                                  | Description                 |
|---------------------------------------|-----------------------------|
| J1 - J3                               | PC Mount SMA RF Connector   |
| J4 - J6                               | DC Pin                      |
| C1 - C3                               | 330 pF capacitor, 0603 Pkg. |
| U1                                    | HMC197 SPDT Switch          |
| PCB*                                  | 101658 Evaluation PCB       |
| * Circuit Board Material: Rogers 4350 |                             |

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 ohm impedance and the package ground leads and package bottom should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.